#### **SDLS100**

- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

#### description

These devices contain four independent 2-input OR gates.

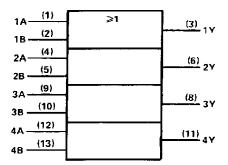
The SN5432, SN54LS32 and SN54S32 are characterized for operation over the full military range of -55°C to 125°C. The SN7432, SN74LS32 and SN74S32 are characterized for operation from 0°C to 70°C.

#### FUNCTION TABLE (each gate)

INP	UTS	OUTPUT
A	B	Ŷ
н	х	н
х	н	н
L	L	L

logic symbol<sup>†</sup>

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<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

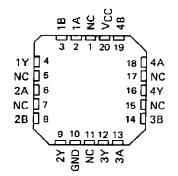
Pin numbers shown are for D. J. N. or W packages.

### SN5432, SN54LS32, SN54S32, SN7432, SN74LS32, SN74S32 QUADRUPLE 2-INPUT POSITIVE-OR GATES DECEMBER 1983 - REVISED MARCH 1988

SN5432, SN54LS32, SN54S32 ... J OR W PACKAGE SN7432 . . . N PACKAGE SN74LS32, SN74S32 . . . D OR N PACKAGE (TOP VIEW)

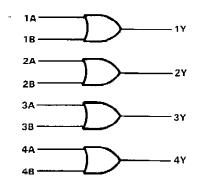
1A []1 1B []2 1Y []3 2A []4 2B []5	14 VCC 13 4B 12 4A 11 4Y 10 3B
2B 5 2Y 6	_
	8 3Y

SN54LS32, SN54S32 ... FK PACKAGE (TOP VIEW)



NC - No internal connection

logic diagram



positive logic

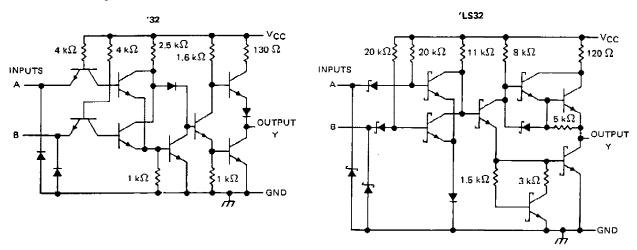
$$Y = A + B \text{ or } Y = \overline{A \cdot B}$$

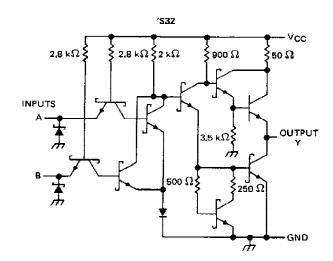
PRODUCTION DATA documents contain information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warrenty. Production processing does not necessarily include testing of all parameters.



## SN5432, SN54LS32, SN54S32, SN7432, SN74LS32, SN74S32 QUADRUPLE 2-INPUT POSITIVE-OR GATES

schematics (each gate)





Resistor values shown are nominal.

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#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)	
Input voltage: '32, 'S32	5.5 V
′L\$32	
Operating free-air temperature: SN54'	
SN74′	0°C to 70°C
Storage temperature range	
NOTE 1: Voltage values are with respect to network ground terminal.	



### recommended operating conditions

			SN5432			SN7432			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	v	
⊻ін	Hgh-level input voltage	2			2			V	
VIL	Low-level imput voltage			0.8			0,8	v	
юн	High-level output current			- 0.8			~ 0.8	mA	
IOL.	Low-level output current			16			16	mА	
TA	Operating free-air temperature	- 55		125	0		70	°C	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

BARAMETER		TEST CONDIT			SN5432			SN7432		
PARAMETER					TYP‡	ΜΑΧ	MIN	TYP‡	MAX	UNIT
 VIK	VCC = MIN,	li = - 12 mA				- 1.5			- 1,5	v
V <sub>OH</sub>	V <sub>CC</sub> = MIN,	V <sub>IH</sub> ≈ 2 V,	I <sub>OH</sub> ≠ − 0.8 mA	2.4	3.4		2.4	3.4		V
VOL	V <sub>CC</sub> = MIN,	V <u>iL</u> ≈ 0.8 V,	IOL = 16 mA		0,2	0.4		0.2	0.4	V
Ц	V <sub>CC</sub> = MAX,	V1 = 5.5 V				1			1	mΑ
_чн	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 2.4 V				40			40	μA
հե	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 0.4 V				1.6			- 1.6	mΑ
OS§	VCC = MAX			- 20		- 55	- 18		- 55	mА
ІССН	V <sub>CC</sub> = MAX,	See Note 2			15	22		15	22	mA
	VCC * MAX,	V1 = 0 V			23	38		23	38	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
 ‡ All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.
 § Not more than one output should be shorted at a time.

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NOTE 2: One input at 4.5 V, all others at GND.

## switching characteristics, V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	MIN	TYP	МАХ	UNIT	
TPLH	A or 8	×	R <sub>L</sub> = 400 Ω,	C. = 15 = 5		10	15	ris
<sup>t</sup> PHL	7018	· · · · · · · · · · · · · · · · · · ·	κ <u>ι</u> - 400 sz,	CL = 15 pF		14	22	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



### SN54LS32, SN74LS32 QUADRUPLE 2 INPUT POSITIVE OR GATES

#### recommended operating conditions

			SN54LS32			SN74LS32			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
V <sub>CC</sub> Suppl	y voltage	4.5	5	5.5	4.75	5	5.25	V	
VIH Hgh-le	evel input voltage	2			2			V	
VIL Low-	evel input voltage			0.7			0.8	V	
OH High-I	level output current			- 0,4			- <b>D</b> .4	mĀ	
OL Low-I	evel output current			4			8	mΑ	
TA Opert	ating free-air temperature	- 55		125	0		70	°C	

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

					SN54LS	32		SN74LS	32	
PARAMETER	TEST CONDITIONS †			MIN	TYP\$	MAX	MIN	TYP‡	MAX	
Viĸ	V <sub>CC</sub> - MIN,	l <sub>1</sub> = 18 mA				- 1.5			- 1.5	v
∨он	VCC = MIN,	V <sub>IH</sub> = 2 V,	I <sub>OH</sub> = - 0.4 mA	2.5	3.4	•	2.7	3.4		V
14	VCC = MIN,	VIL = MAX,	10L = 4 mA		0.25	0.4		0.25	0.4	v
VOL	V <sub>CC</sub> = MIN,	V <sub>IL</sub> = MAX,	IOL = 8 mA					0.35	0.5	ľ v
1	V <sub>CC</sub> - MAX,	V <sub>1</sub> = 7 V				0.1			0.1	mA
- IH	VCC = MAX,	V <sub>I</sub> = 2.7 V			•	20			20	μA
IIL.	V <sub>CC</sub> = MAX,	VI = 0.4 V				- 0.4			- 0.4	mA
IOS§	VCC = MAX			- 20		- 100	- 20		- 100	mΑ
Іссн	V <sub>CC</sub> = MAX,	See Note 2			3.1	6.2		3.1	6.2	mA
ICCL	VCC = MAX,	V  = 0 V		l	4.9	9.8	I	4.9	9.8	mΑ

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

f All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ . § Not more than one output should be shorted at a time and the duration of the short-circuit should not exceed one second. NOTE 2: One input at 4.5 V, all others at GND.

#### switching characteristics, $V_{CC} = 5 V$ , $T_A = 25^{\circ}C$ (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS			түр	МАХ	UNIT
tPLH	1 az 0	V	<b>D</b> 010	0 - 15 -		14	22	пs
<sup>t</sup> PHL	A or B	T	$R_{L} = 2 k \Omega,$	CL = 15 pF		14	22	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



#### recommended operating conditions

			SN5453	2		SN74S3	2	
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	v
Viн	High-level input voltage	2			2			v
VIL	Low-level input voltage			0.8			0.8	v
юн	High-level output current			1			- 1	mΑ
<sup>I</sup> OL	Low-level output current			20			20	mΑ
TA	Operating free-air temperature	- 55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

		TEST CONDIT			SN54S3	2				
PARAMETER		TEST CONDITIONS :		MIN	TYP ‡	MAX	MIN	TYP #	MAX	UNIT
VIK	VCC = MIN,	lj = — 18 mA				- 1.2			- 1.2	V
∨он	V <sub>CC</sub> = MIN,	V <sub>IH</sub> = 2 V,	10H = - 1 mA	2.5	3.4		2.7	3.4		V
VoL	VCC = MIN,	V <sub>IL</sub> = 0.8 V,	IOL = 20 mA			0.5			0.5	V
4	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 5.5 V				1			1	mA
Чн	VCC = MAX,	V  = 2.7 V				50			50	μA
hΓ	V <sub>CC</sub> = MAX,	Vi = 0.5 V				- 2			- 2	MA
los§	V <sub>CC</sub> = MAX			- 40		— 1 <b>00</b>	- 40		- 100	mA
Іссн	V <sub>CC</sub> = MAX,	See Note 2			18	32		18	32	mA
ICCL	VCC = MAX,	V1 = 0 V			- 38	68		- 38	68	mA

2

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† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. ‡ All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ . § Not more than one output should be shorted at a time and the duration of the short-circuit should not exceed one second. NOTE 2: One input at 4.5 V, all others at GND.

switching characteristics, VCC = 5 V, TA =  $25^{\circ}$ C (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	MIN TY	P MAX	UNIT	
tPLH		v	<b>D</b> = 200 O	C <sub>I</sub> = 15 pF		4 7	ns
tPHL	A or B		RL ≖ 280 Ω,			4 7	ns
tPLH	A or 8	v	Ri = 280 Ω,	CI = 50 pF		5	пs
<sup>t</sup> ₽HL			ni <b>100</b> 02,			5	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.





## PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
5962-9557401QCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9557401QC A SNJ5432J	Samples
5962-9557401QDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9557401QD A SNJ5432W	Samples
5962-9557401QDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9557401QD A SNJ5432W	Samples
JM38510/30501B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501B2A	Samples
JM38510/30501B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501B2A	Samples
JM38510/30501BCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501BCA	Samples
JM38510/30501BCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501BCA	Samples
JM38510/30501BDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501BDA	Samples
JM38510/30501BDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501BDA	Samples
JM38510/30501SCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501SCA	Samples
JM38510/30501SCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501SCA	Samples
JM38510/30501SDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501SDA	Samples
JM38510/30501SDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501SDA	Samples
M38510/30501B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501B2A	Samples
M38510/30501B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501B2A	Samples



# PACKAGE OPTION ADDENDUM

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Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Sample
M38510/30501BCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501BCA	Sample
M38510/30501BCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501BCA	Sample
M38510/30501BDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type -55 to 125		JM38510/ 30501BDA	Sample
M38510/30501BDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501BDA	Sample
M38510/30501SCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501SCA	Sample
M38510/30501SCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501SCA	Sample
M38510/30501SDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501SDA	Sampl
M38510/30501SDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501SDA	Sampl
SN5432J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type -55 to 125		SN5432J	Sampl
SN5432J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN5432J	Sampl
SN54LS32J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS32J	Sampl
SN54LS32J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS32J	Sampl
SN54S32J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54S32J	Sampl
SN54S32J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54S32J	Sampl
SN7432N	ACTIVE	PDIP	Ν	14	25	RoHS & Green	NIPDAU	NIPDAU N / A for Pkg Type 0 to		SN7432N	Sampl
SN7432N	ACTIVE	PDIP	Ν	14	25	RoHS & Green	NIPDAU      N / A for Pkg Type      0 to 70      SN7432N		SN7432N	Sampl	
SN7432NE4	ACTIVE	PDIP	Ν	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN7432N	Sampl
SN7432NE4	ACTIVE	PDIP	Ν	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN7432N	Sampl



14-Aug-2021

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN74LS32D	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS32	Samples
SN74LS32D	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS32	Samples
SN74LS32DBR	ACTIVE	SSOP	DB	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS32	Samples
SN74LS32DBR	ACTIVE	SSOP	DB	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS32	Samples
SN74LS32DE4	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS32	Samples
SN74LS32DE4	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS32	Samples
SN74LS32DG4	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS32	Samples
SN74LS32DG4	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS32	Samples
SN74LS32DR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS32	Samples
SN74LS32DR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS32	Samples
SN74LS32DRE4	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS32	Samples
SN74LS32DRE4	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS32	Samples
SN74LS32DRG4	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS32	Samples
SN74LS32DRG4	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS32	Samples
SN74LS32N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS32N	Samples
SN74LS32N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS32N	Samples
SN74LS32NE4	ACTIVE	PDIP	Ν	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS32N	Samples
SN74LS32NE4	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS32N	Samples
SN74LS32NSR	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS32	Samples
SN74LS32NSR	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS32	Samples
SN74LS32NSRG4	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS32	Samples



Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN74LS32NSRG4	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS32	Sample
SN74S32D	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	S32	Sample
SN74S32D	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	PDAU Level-1-260C-UNLIM		S32	Sample
SN74S32DR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	S32	Sample
SN74S32DR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	S32	Sample
SN74S32N	ACTIVE	PDIP	Ν	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74S32N	Sample
SN74S32N	ACTIVE	PDIP	Ν	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74S32N	Sample
SNJ5432J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9557401QC A SNJ5432J	Sample
SNJ5432J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9557401QC A SNJ5432J	Sample
SNJ5432W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9557401QD A SNJ5432W	Sample
SNJ5432W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9557401QD A SNJ5432W	Sample
SNJ54LS32FK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS 32FK	Sample
SNJ54LS32FK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS 32FK	Sample
SNJ54LS32J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS32J	Sample
SNJ54LS32J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	NPB N / A for Pkg Type		SNJ54LS32J	Sample
SNJ54LS32W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS32W	Sample
SNJ54LS32W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS32W	Sample

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SNJ54S32J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S32J	Samples
SNJ54S32J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S32J	Samples
SNJ54S32W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S32W	Samples
SNJ54S32W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S32W	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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## PACKAGE OPTION ADDENDUM

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

#### OTHER QUALIFIED VERSIONS OF SN5432, SN54LS32, SN54LS32-SP, SN54S32, SN7432, SN74LS32, SN74S32 :

- Catalog : SN7432, SN74LS32, SN54LS32, SN74S32
- Military : SN5432, SN54LS32, SN54S32
- Space : SN54LS32-SP

#### NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications
- Space Radiation tolerant, ceramic packaging and qualified for use in Space-based application

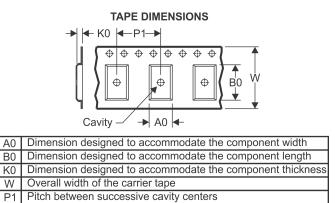
# PACKAGE MATERIALS INFORMATION

Texas Instruments

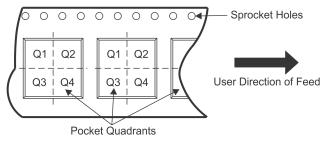
www.ti.com

## TAPE AND REEL INFORMATION





## QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



All dimensions are nominal Device	1	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS32DBR	SSOP	DB	14	2000	330.0	16.4	8.35	6.6	2.4	12.0	16.0	Q1
SN74LS32DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
SN74LS32NSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
SN74S32DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1



# PACKAGE MATERIALS INFORMATION

19-Jun-2021



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS32DBR	SSOP	DB	14	2000	853.0	449.0	35.0
SN74LS32DR	SOIC	D	14	2500	853.0	449.0	35.0
SN74LS32NSR	SO	NS	14	2000	853.0	449.0	35.0
SN74S32DR	SOIC	D	14	2500	853.0	449.0	35.0

LEADLESS CERAMIC CHIP CARRIER

FK (S-CQCC-N\*\*) 28 TERMINAL SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004



## MECHANICAL DATA

### PLASTIC SMALL-OUTLINE PACKAGE

### 0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 $\bigcirc$ Gage Plane ₽ 0,25 7 1 1,05 0,55 0°-10° Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS \*\* 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G\*\*)

**14-PINS SHOWN** 

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only.
  - E. Falls within MIL STD 1835 GDFP1-F14



# **GENERIC PACKAGE VIEW**

# CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



# J0014A



# **PACKAGE OUTLINE**

## CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



NOTES:

- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
  Falls within MIL-STD-1835 and GDIP1-T14.



# J0014A

# **EXAMPLE BOARD LAYOUT**

## CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE





D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.





NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



# N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- $\triangle$  The 20 pin end lead shoulder width is a vendor option, either half or full width.



## **MECHANICAL DATA**

MSSO002E - JANUARY 1995 - REVISED DECEMBER 2001

## DB (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-150



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